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Terms	Documents
L60 and l49	89

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L61

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result set

DB=USPT; PLUR=YES; OP=OR

<u>L61</u>	L60 and l49	89	<u>L61</u>
<u>L60</u>	L59 same l24	4027	<u>L60</u>
<u>L59</u>	l58 near5 l57	22325	<u>L59</u>
<u>L58</u>	solder or soldering or soldered or bond or bonding or bonded	558544	<u>L58</u>
<u>L57</u>	pin or leg our cutout or (cut adj out) or cut-out or connector	1058486	<u>L57</u>
<u>L56</u>	l49 and (l5 same l24)	12	<u>L56</u>
<u>L55</u>	l52 not L54	53	<u>L55</u>
<u>L54</u>	l52 not l53	5	<u>L54</u>
<u>L53</u>	L52 and (hole or slit or opening or l23)	53	<u>L53</u>
<u>L52</u>	L51 and l29	58	<u>L52</u>
<u>L51</u>	l49 and l43	324	<u>L51</u>
<u>L50</u>	L49 and l48	106	<u>L50</u>
<u>L49</u>	((228/180.1)!.CCLS.)	635	<u>L49</u>

<u>L48</u>	L47 and solder	132	<u>L48</u>
<u>L47</u>	L46 and (l40 or l1 or l4)	182	<u>L47</u>
<u>L46</u>	terminal and l45	296	<u>L46</u>
<u>L45</u>	(428/575 OR 428/595 OR 428/596 OR 428/603 OR 428/620 OR 228/180.1).CCLS.	2372	<u>L45</u>
<u>L44</u>	l43 and l42	1288	<u>L44</u>
<u>L43</u>	(printed or circuit or pwb or pcb or semiconductor).ti,ab.	341960	<u>L43</u>
<u>L42</u>	l41 same (circuit or printed)	2253	<u>L42</u>
<u>L41</u>	l40 near4 l39	20235	<u>L41</u>
<u>L40</u>	heating or cooling	749307	<u>L40</u>
<u>L39</u>	mounting or mounted or mount	1278429	<u>L39</u>
<i>DB=JPAB; PLUR=YES; OP=OR</i>			
<u>L38</u>	"kadokawa, kazuto".in.	1	<u>L38</u>
<u>L37</u>	"kazuto kadokawa".in.	0	<u>L37</u>
<u>L36</u>	kadokawa.in.	561	<u>L36</u>
<u>L35</u>	2000363550.did.	0	<u>L35</u>
<u>L34</u>	2000363550.did,	0	<u>L34</u>
<i>DB=USPT; PLUR=YES; OP=OR</i>			
<u>L33</u>	l32 same solder	223	<u>L33</u>
<u>L32</u>	l31 near5 (hole or slit or opening)	1284	<u>L32</u>
<u>L31</u>	l24 near10 terminal	8614	<u>L31</u>
<u>L30</u>	L29 and l28	54	<u>L30</u>
<u>L29</u>	radiation or radiating or radiate or (heat near2 (plate or conductor)) or l4	313062	<u>L29</u>
<u>L28</u>	L27 and l26	161	<u>L28</u>
<u>L27</u>	l2.ti,ab.	1584	<u>L27</u>
<u>L26</u>	L25 same solder	3377	<u>L26</u>
<u>L25</u>	L24 near5 l23	20790	<u>L25</u>
<u>L24</u>	L2 or (pcb or (printed near2 circuit near2 board))	79215	<u>L24</u>
<u>L23</u>	fastener or connector or connection or attachement or attached	1830869	<u>L23</u>
<u>L22</u>	L20 and l2	16	<u>L22</u>
<u>L21</u>	L20 same l2	1	<u>L21</u>
<u>L20</u>	terminal near2 regulator	2407	<u>L20</u>
<i>DB=JPAB; PLUR=YES; OP=OR</i>			
<u>L19</u>	l1 and (pin or hole or opening or leg or projection)	0	<u>L19</u>
<u>L18</u>	l1 and (l12 or l13)	0	<u>L18</u>
<u>L17</u>	05095092.pn.	1	<u>L17</u>
<i>DB=USPT; PLUR=YES; OP=OR</i>			
<u>L16</u>	L15 and l5	2	<u>L16</u>
<u>L15</u>	L14 same (solder or soldered or soldering)	14	<u>L15</u>
<u>L14</u>	L13 near10 l12	1026	<u>L14</u>
<u>L13</u>	insert near2 (opening or hole)	13104	<u>L13</u>

<u>L12</u>	(engaging or engagement or attaching or attachment or leg)	1058692	<u>L12</u>
<u>L11</u>	L10 and l8	58	<u>L11</u>
<u>L10</u>	l5 near5 (l6 or hole)	1746	<u>L10</u>
<u>L9</u>	L5 near5 l6	752	<u>L9</u>
<u>L8</u>	l2 same l5	288	<u>L8</u>
<u>L7</u>	solder or soldered or soldering or connection or connecting or attachment or attached	1965110	<u>L7</u>
<u>L6</u>	leg or connector or slit	567198	<u>L6</u>
<u>L5</u>	l4 or l1	32420	<u>L5</u>
<u>L4</u>	heat near2 sink	31399	<u>L4</u>
<u>L3</u>	l2 same l1	14	<u>L3</u>
<u>L2</u>	pwb or (printed near2 wiring near2 board)	8689	<u>L2</u>
<u>L1</u>	heat near2 (radiation or radiating or radiate) near2 plate	1254	<u>L1</u>

END OF SEARCH HISTORY